

**Product Description** 

matched paths.

# **Product Specification**

# PE42920

**UltraCMOS® Passive DDSPDT High-Isolation RF Switch** 10 kHz-6 GHz

#### **Features**

- Dual differential single pole double throw swital
- Low frequency insertion loss: 0.7 dB
- at 6 GHz. 26 dB typical
- pannels at 6 GHz: 30 dB typical
  - Low phase mismatch between matched paths at 6 GHz: 15 degrees typical

- Broadband, 10 kl
- ligh isolation between same channels
- High isolation between opposite active
- igh ESD performance: 2 kV HBM

The PE42920 is manufactured on Peregrine's UltraCMOS process, a patented variation of silicon-oninsulator (SOI) technology on a sapphire substrate, offering the performance of GaAs with the economy a integration of conventional CMOS.

The PE42920 is a dual differential single pole double

low loss device enabling the switching of two

throw (DDSPDT) RF switch developed on Peregrine's

UltraCMOS® process technology. It is a broadband and

independent differential signals. This device consumes

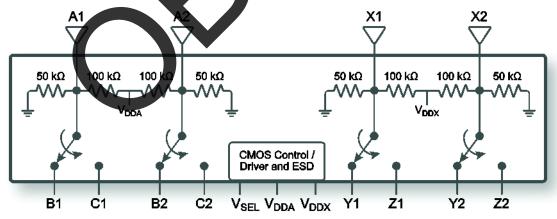
less power than active differential switches and offers 2 kV HBM ESD protection. It has high isolation between same channel inputs as well as opposite active channels.

It has been designed for low phase mismatch between

Figure 2. Package Type 16-lead 3 x 3 mm QFN



Figure 1. Functional Di



Note: Differential pairs B1/B2 and Y1/Y2 must be switched simultaneously to pairs C1/C2 and Z1/Z2. See Table 5, Truth Table.

DOC-52427



Table 1. Typical Specifications  $V_{DD}$  = 3.3V, Temp = +25 °C ( $Z_S$  =  $Z_L$  = 100 $\Omega$  differential) Min/Max Specifications  $V_{DD}$  = 3.3V ±10%, -40 °C  $\leq$  Temp  $\leq$  +85 °C, ( $Z_S$  =  $Z_L$  = 100 $\Omega$  differential)

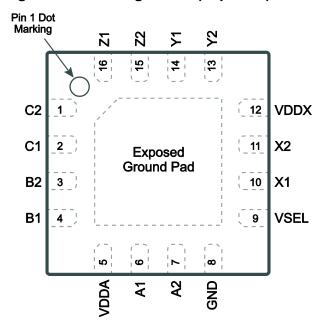
AC coupled - external DC blocking caps

Electrical Parameter	Condition/Notes			Min	Тур	Max	Unit
Operating frequency	Frequency range		10 kHz		6 GHz	As shown	
Operating frequency	Differential 3 dB bandwidth		5.6	6		GHz	
Insertion loss at 10 kHz	V <sub>CM</sub> = 1.1V				0.7	1.25	dB
Insertion loss at 1 GHz	V <sub>CM</sub> = 1.1V			. <	1.0	1.4	dB
Isolation between same channel inputs at 6 GHz	A to C when B is ON. A to B wh X to Z when Y ON. X to Y when			24	26		dB
Isolation between opposite (active) channels at 6 GHz	Channels A ↔ X. V <sub>CM</sub> = 1.1V	Channels A $\leftrightarrow$ X. $V_{CM} = 1.1V$			30		dB
Input 1dB compression* (P <sub>1dB</sub> )	VCM = 1.1V, differential	VCM = 1.1V, differential			13		dBm
Return loss common ports A and X	Differential	50–1250 M 1250–2500 M 2500–400 M	Hz	12.5 8 5.5	14 9 8		dB dB dB
	Single ended	50–1250 MN 1250–2500 M 2500–4000 M	Hz	14.5 12 10.5	17.5 14 13		dB dB
Return loss active ports B, C, Y, Z	Differential	50–1250 MH 1250–2500 M 2500–4000 M	Hz	12.5 8.5 8	15.5 9.5 9.5		dB dB dB
	Single ended	50–1250 MHz 250–2500 MHz 2500–4000 MHz		16 13 10.5	18.5 16 14.5		dB dB dB
Switching time	50% control to 10/90% RF				270	450	ns
Phase mismatch on matched paths at 6 GHz	$V_{SEL} = 1$ matched paths (A1 $\leftrightarrow$ B1 & A2 $\leftrightarrow$ B2) (X1 $\leftrightarrow$ Y1 & X2 $\leftrightarrow$ Y2)	$V_{SEL} = 0$ matched paths (A1 $\leftrightarrow$ C1 & A2 $\leftrightarrow$ C2) X1 $\leftrightarrow$ Z1 & X2 $\leftrightarrow$ Z2)	V <sub>CM</sub> = 1.1V		15	30	degrees
Phase mismatch on un-matched paths at 6 GHz	Unmatched: average of A1,A2	delay to average of X1,X2	V <sub>CM</sub> = 1.1V		22	50	degrees
Phase delta stability	Across voltage and temperature				2	degrees	
Common mode voltage	Common port self piased V <sub>CM</sub> (V <sub>cm</sub> ≈ V <sub>DD</sub> /3)			1.1		V	
Common mode impedance	Common port bias resistances				100 50		kΩ kΩ
Input IP3	Single ended (see Figure 19)					dBm	

Note: \* P1dB is an indication of device linearity, max operating power is restricted to limits in Table 3.



Figure 3. Pin Configuration (Top View)



**Table 2. Pin Descriptions** 

Pin No.	Pin Name	Description	
1	C2	C-channel [Logic Low] RF Fort –	
2	C1	C-channel [Logic Low] RF Port +	
3	B2	B-channel [Logic High] RF Port -	
4	B1	B-channel [Logic High] RF Port +	
5	VDDA	A-channel Supply	
6	A1	A-channel RF Common Port +	
7	A2	A-channel RF Compton Port	
8	GND	Ground	
9	VSEL	Simultaneous Logic Select	
10	X1	X-channel RF Common Port +	
11	X2	X-channel RF Common Port –	
12	VDDX	X-channel Supply	
13	Y2	Y-channel [Logic High] RF Port -	
14	Y1	Y-channel [Logic High] RF Port +	
15	Z2	Z-channel [Logic Low] RF Port –	
16	Z1	Z-channel [Logic Low] RF Port +	
Paddle	GND	Exposed solder pad: Ground for proper operation	

Table 3. Operating Ranges<sup>2</sup>

Parameter	Min	Тур	Max	Unit
V <sub>DD</sub> <sup>1</sup> Power Supply Voltage	2.97	3.3	3.63	V
I <sub>DD</sub> Supply Current		100	500	μΑ
T <sub>OP</sub> Operating Temperature	-40		85	°C
P <sub>DC</sub> DC Power Consumption			2	mW
V <sub>IH</sub> V <sub>SEL</sub> Control Voltage High	0.7xV <sub>DD</sub>		$V_{DD}$	٧
V <sub>IL</sub> V <sub>SEL</sub> Control Voltage Low	0		0.31V <sub>DD</sub>	٧
I <sub>IH</sub> /I <sub>IL</sub> I <sub>SEL</sub> Control Current Input High/Low	1		1	μΑ
P <sub>MAX</sub> Max. Input Fower (100Ω Differential, Active Pon)			10	dBm
P <sub>MAX</sub> Max Input Power (50Ω Single Ended Active Port)			7	dBm
V <sub>PEAK TO REAK</sub> Max Juput Differential (100Ω) Single Ended (50Ω)			2.8 1.4	$V_{PP}$

1. Opera 2. Opera pw min.  $V_{DD}$  results in degraded performance. Soluble be restricted to the limits in the Operating Ranges Notes:

table.

## Absolute Maximum Ratings

Parameter/Condition	Min	Max	Unit
P <sub>MAX</sub> Max. Input Power (100Ω Differential, Active Port)		10	dBm
P <sub>MAX</sub> Max. Input Power (50Ω Single Ended, Active Port)		7	dBm
V <sub>SEL</sub> Control Voltage		4	V
I <sub>SW</sub> DC Current on RF Path		5	mA
T <sub>ST</sub> Storage Temperature	-65	+150	°C
V <sub>ESD</sub> HBM ESD Voltage <sup>1</sup>		2000	V
V <sub>ESD</sub> MM ESD Voltage <sup>2</sup>		100	V
V <sub>PEAK-TO-PEAK</sub> Max Input Differential (100Ω) Single Ended (50Ω)		2.8 1.4	$V_{PP}$

Notes: 1. HBM ESD Voltage (HBM, MIL\_STD 883, Method 3015.7).

2. MM ESD Voltage (JESD22-A115-A).

Exceeding absolute maximum ratings may cause permanent damage. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

#### **Electrostatic Discharge (ESD) Precautions**

When handling this UltraCMOS device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the specified rating.

#### Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS devices are immune to latch-up.

#### **Moisture Sensitivity Level**

The Moisture Sensitivity Level rating for the PE42920 in the 16-lead 3 × 3 mm QFN package is MSL1.

**Table 5. Truth Table: Signal-Path Control Logic** 

Path	Channel A		Chan	nel X
V <sub>SEL</sub>	A→B	A→C	X→Y	X→Z
Low	OFF	ON	OFF	ON
High	ON	OFF	ON	OFF

A = Differential pair A1/A2 C = Differential pair C1/C2 Y = Differential pair Y1/Y2 B = Differential pair B1/B2 X = Differential pair X1/X2

Z = Differential pair X1/X2





### Typical Performance Data @ 3.3V and +25 °C, unless otherwise specified

Figure 4. Differential Insertion Loss over V<sub>DD</sub>

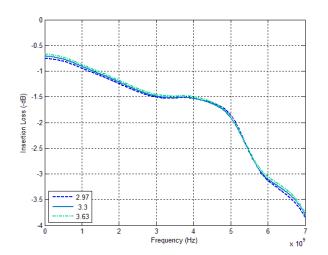


Figure 5. Differential Insertion Loss over Temp

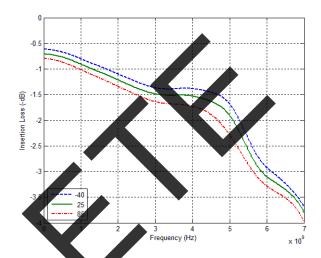


Figure 6. Differential Active Port (B, C, Y, or Z) Return Loss over V<sub>DD</sub>

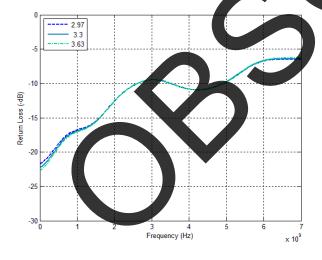
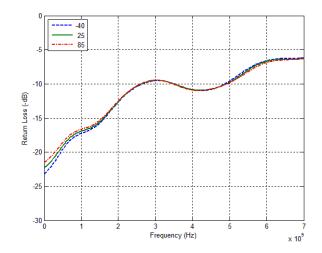


Figure 7. Differential Active Port (B, C, Y, or Z)
Return Loss over Temp





#### Typical Performance Data @ 3.3V and +25 °C, unless otherwise specified

Figure 8. Differential Common Port (A or X) Return Loss over  $V_{DD}$ 

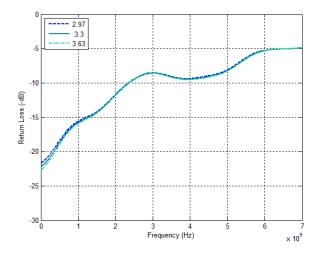


Figure 9. Differential Common Port (A or X)
Return Loss over Temp

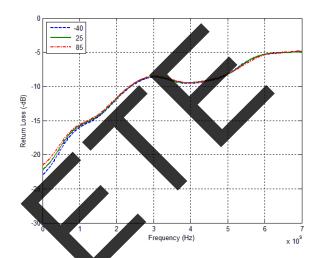


Figure 10. Single-Ended Active Port (B1, B2, C1, C2, Y1, Y2) Return Loss over V<sub>DD</sub>

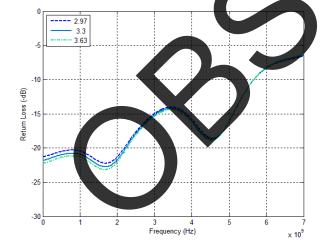
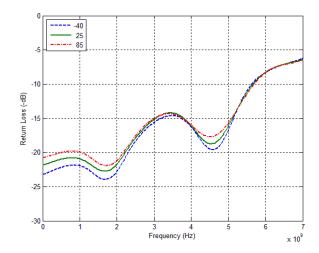


Figure 11. Single-Ended Active Port (B1, B2, C1, C2, Y1, Y2) Return Loss over Temp





Typical Performance Data @ 3.3V and +25 °C, unless otherwise specified (cont.)

Figure 12. Single-Ended Common Port (A1, A2, X1, X2) Return Loss over V<sub>DD</sub>

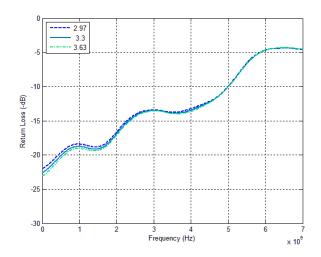


Figure 13. Single-Ended Common Port (A1, A2, X1, X2) **Return Loss over Temp** 

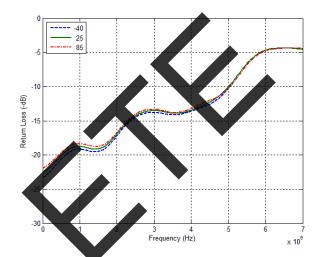


Figure 14. Opposite Channel (A to X) Isolation over V<sub>DD</sub>

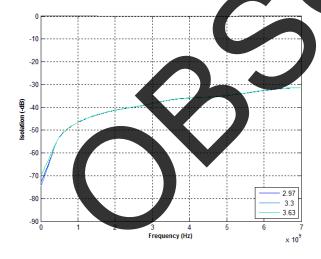
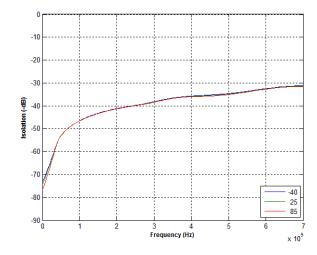


Figure 15. Opposite Channel (A to X)
Isolation over Temp





Typical Performance Data @ 3.3V and +25 °C, unless otherwise specified (cont.)

Figure 16. Same Channel (A to B/C and X to Y/Z) Isolation over  $V_{DD}$ 

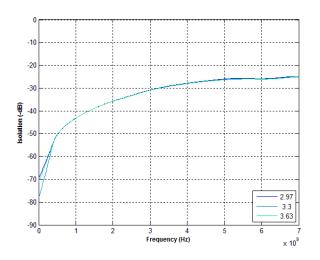


Figure 17. Same Channel (A to B/C and X to Y/Z) Isolation over Temp

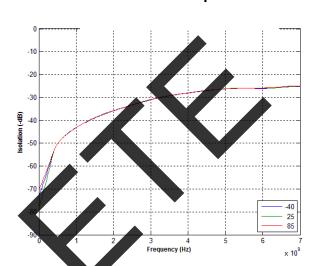


Figure 18. Switching Time (10/90% RF)

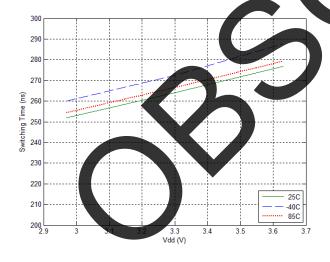


Figure 19. IIP3 (Single Ended)

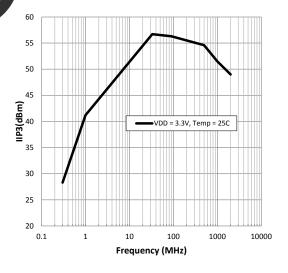




Figure 20. Phase Delta Matched Paths (6 GHz and +25 °C) Stability Across V<sub>DD</sub>

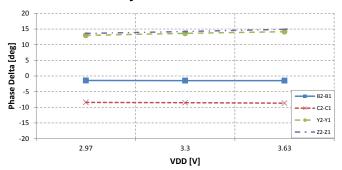


Figure 21. Phase Delta Matched Paths (6 GHz and 3.3V) **Stability Across Temp** 

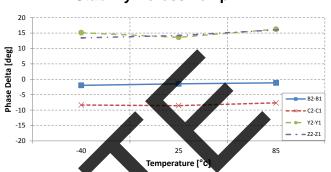
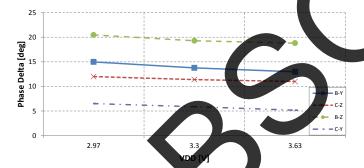
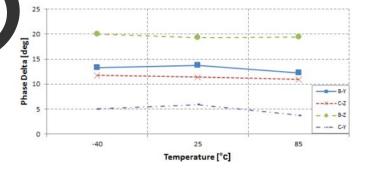


Figure 22. Phase Delta Un-matched Paths (6 GHz and +25 °C) Stability Across V<sub>DD</sub>



igure 23 Phase Delta Un-matched Paths (6 GHz and 3.3V) Stability Across Temp





#### **Evaluation board**

The DDSPDT switch evaluation kit board was designed to ease customer evaluation of the PE42920 DDSPDT switch.

Calibration structures are available on the bottom side of the PCB. As an alternate connector option, a through transmission line connects connectors J14 and J13. This transmission line can be used to estimate the loss of the PCB over the environmental conditions being evaluated.

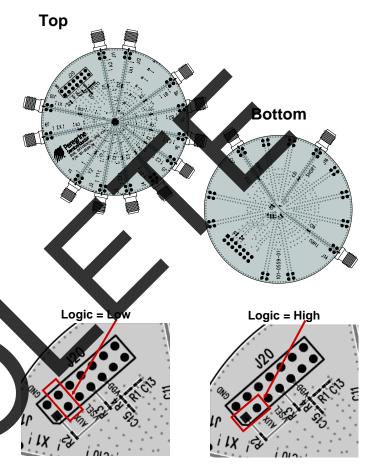
J20 provides a means for applying  $V_{DD}$  and controlling the logic of the device. A jumper can be used to set AUX =  $V_{DD}$  or AUX = GND,\* to toggle the logic state.

Proper PCB design is essential for full isolation performance. This evaluation board demonstrates good trace and ground management for minimum coupling and radiation.

DC blocking capacitors (external or on board) are required to prevent interaction with external test equipment. They can be used as external broadband DC blocks or replace  $0\Omega$  resistors on board with the desired capacitance value on operation frequency.

Note: \* Silkscreen Error – AUX and V<sub>SEL</sub> labels are swapped. AUX jumper proportion J20 header is equivalent to the V<sub>SEL</sub> control in the block diagram. V<sub>SEL</sub> jumper pin on J20 header is a no contest.

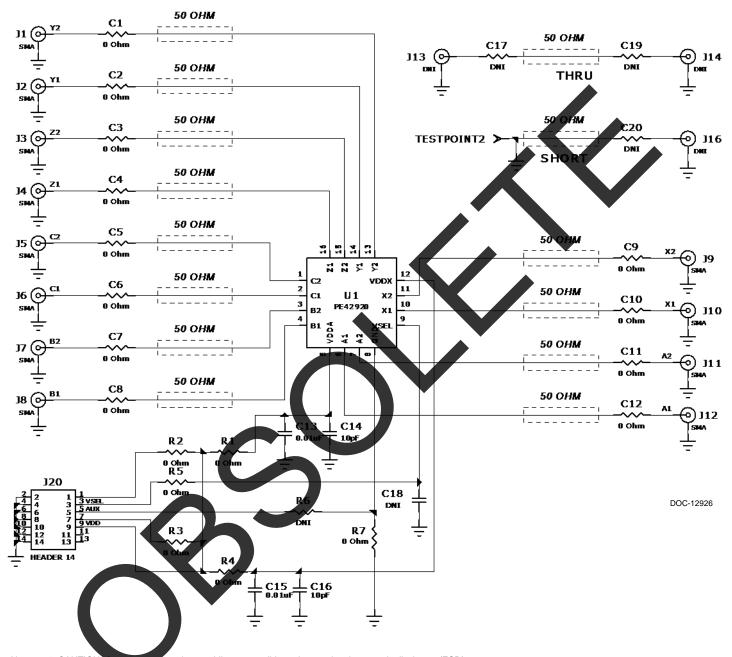
Figure 24. Evaluation Board Layouts



PRT-09905



Figure 25. Evaluation Board Schematic 1,2,3



Notes: 1. CAUTION: Sontains parts and assemblies susceptible to damage by electrostatic discharge (ESD).

2. Silkscreen error: AUX and VSEL labels are swapped on PCB at J20 location.

3. Pin 8 is grounded in PE42920.



# Figure 26. Package Drawing 16-lead 3 × 3 mm QFN

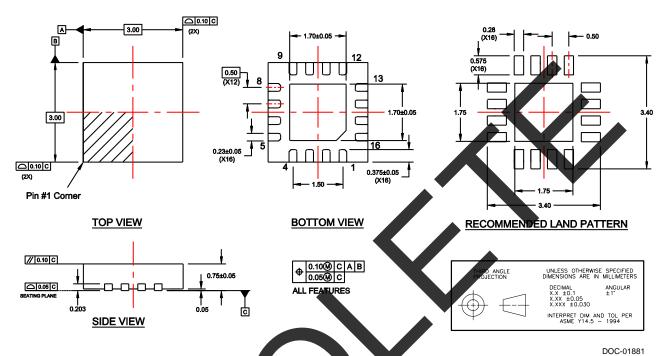


Figure 27. Top Marking Specification



DOC-66062



Figure 28. Tape and Reel Specifications

3.30

3.30

1.10

1.50 + 0.1/ -0.0

1.5 min

 $1.75 \pm 0.10$ 

 $5.50 \pm 0.05$ 

4.00

8.00

 $2.00 \pm 0.05$ 

 $0.30 \pm 0.05$ 

12.00 ± 0.3

**A0** 

**B**0

K0

D0

D1

F

F

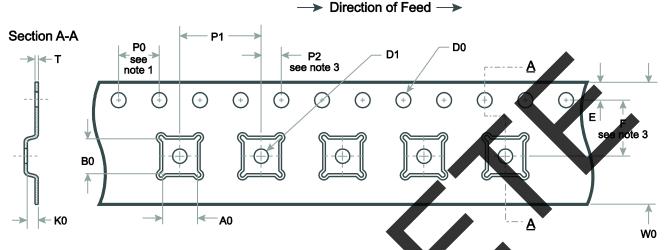
P0

P1

P2

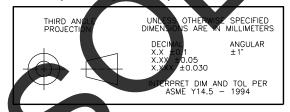
W0

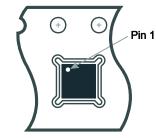
16-lead 3x3 mm QFN



#### Notes:

- 1. 10 Sprocket hole pitch cumulative tolerance ±0
- 2. Camber in compliance with EIA 481
- 3. Pocket position relative to spre et hole measured as true position o not po hole





**Device Orientation in Tape** 

#### Table 6. Ordering Inform

Order Code	Description	Package	Shipping Method
PE42920MLAA-Z	PE42920 DDSPDT RF Switch	Green 16-lead 3 x 3 mm QFN	3000 units T/R
EK42920-01	PE42920 Evaluation Board	Evaluation Kit	1/box

#### **Sales Contact and Information**

For sales and contact information please visit www.psemi.com.

Advance Information: The product is in a formative or design stage. The datasheet contains design target specifications for product development. Specifications and features may change in any manner without notice. **Preliminary Specification:** The datasheet contains preliminary data. Additional data may be added at a later date. Peregrine reserves the right to change specifications at any time without notice in order to supply the best possible product. Product Specification: The datasheet contains final data. In the event Peregrine decides to change the specifications, Peregrine will notify customers of the intended changes by issuing a CNF (Customer

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